

## IUMRS-ICA2017(11月台湾)熱電シンポジウムのお知らせ

国際交流委員会委員長  
森 孝雄

熱電材料関連のシンポジウムが開催される IUMRS-ICA2017 のお知らせです。  
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国際会議名 : IUMRS-ICA2017  
Symposium B3

日時 : 2017年11月5日～11月9日

場所 : 台北、台湾

ホームページ :

(全体) <http://www.iumrs-ica2017.tw>  
(熱電関連シンポジウム、Symposium B3)

<http://www.iumrs-ica2017.tw/site/mypage.aspx?pid=182&lang=en&sid=1153>

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Posted on: June 26, 2017

Many TMS2018 presenters will travel to Phoenix, Arizona, from other countries to attend TMS2018. Those presenters who require a travel visa to enter the United States are encouraged to [request a visa invitation letter](#) now and to begin the process of applying for a travel visa today.

## CALL FOR PAPERS

### Alloys and Compounds for Thermoelectric and Solar Cell Applications VI

2018 TMS Annual Meeting at Phoenix, Arizona  
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This symposium addresses synthesis, property measurements, phase stability, phase transformation of the alloys and compounds used in the thermoelectric and solar cell devices. Materials of interests include, but not limited to, skutterudites, superlattice, half-Heusler alloys, CdTe, CIS, CIGS, CZTS and new materials for thermoelectric and solar cell applications. Abstracts are due by July 1<sup>st</sup>, 2017. Please submit abstracts directly to TMS Online.

(<http://www.tms.org/tms2018>)

(<http://www.programmaster.org/PM/PM.nsf/UpcomingSymposia/279949F4174B7190852580DD000131A2?OpenDocument&ParentUNID=5565C1172B38125085257DCD006DA70B>).

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